

# Wireless Power Dual-Mode Charging Receiver with RX coil

Evaluation Board Manual

### IDTP9023 CSP Dual-Mode EVALUATION KIT

### Features

- IDTP9023 CSP Evaluation Design Module with Dual-Mode Rx coil
- 4-layer PCB with 1 oz. copper traces
- Fully assembled with test points and coil fixture
- Micro-A/B USB Input/ USB A Output
- USB to I<sup>2</sup>C hardware converter for PC connectivity
- EEPROM to store and load start-up script/firmware
- Software tool to monitor operation, settings control and R/W EEPROM
- LED status indicator
- 5W output power setting

#### **Evaluation Kit Contents**

- IDTP9023 V1.2 EVAL Evaluation board
- JM60 Programming Dongle
- USB type A to micro-USB type B cable
- CD containing:
  - IDTP9023 control software tool
  - PC\_USB Driver software
  - Reference layout Gerber Files
  - Reference layout Cadence Allegro board files
  - Electronic copy of IDTP9023 product datasheet
  - Electronic copy of IDTP9023-EVAL manual

### **Description**

The IDTP9023 "CSP" evaluation board serves to demonstrate the features and performance of the IDTP9023 Dual-Mode Wireless Power Receiver solution for Mobile Devices. The intuitive top-level layout and control simplifies the user experience to emphasize the impressive level of integration and abundance of useful features that this device offers.

The device is powered by a Dual-Mode RX receiver coil attached to a 2mm thick plastic fixture. Dual-Mode receivers will operate with either a WPC or PMA transmitter (Tx). GUI (graphical user interface) software with a USB Type B cabled programmer board (JM60) is provided to program the on-board EEPROM. The evaluation board utilizes an external EEPROM which contains IDTP9023 firmware to enable functions and allow programmability. The external EEPROM memory chip is pre-programmed with a standard start-up program that is automatically loaded when the board is placed upon a PMA or WPC transmitter such as the IDTP9035A TX-A11 EVKIT. The EEPROM can be reprogrammed to suit the needs of specific applications using the IDTP9023 software tool. The core layout is a 4-layer Cadence Allegro reference design that can be copied and integrated into a larger system design.



# **USAGE GUIDE**

The IDTP9023-EVAL demo board is designed to demonstrate the performance and functionality of the IDTP9023 dual-mode WPC/PMA wireless receiver in a lab bench test environment. In most cases, this board can be wired into an existing system for evaluation. For complex or electrically sensitive situations, it is recommended to use the reference layout to integrate this design into the final system to eliminate hardware limitations or signal degradation introduced by long leads.

With no computer interface, this evaluation board can function in its pre-programmed mode of operation using a WPC compatible TX transmitter such as the IDTP9030/35A/36A EVKIT. Optionally, to program the EEPROM a PC with USB output is required. Everything needed is included in this evaluation kit.

#### Quick-Start Guide

- 1. Place the IDTP9023 RX board onto the TX coil of a PMA or WPC compatible transmitter; note that 5V will appear across the SMD test pins BUCK5V and GND on the IDTP9023 board.
- 2. Connect up to a 1A load to the BUCK5V test point and GND.

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### IDTP9023 CSP Dual-Mode EVALUATION KIT



Figure 1. IDTP9023 V1.2 Eval Kit Board Schematic

#### Table 1. Bill of materials (IDTP9023 Dual-Mode Demo PCB V1.2)

| Item Number | Description                             | Qty   | Manufacturer     | Mfr Part Number               | Ref Designator                                     |
|-------------|---|-------|------------------|-------------------------------|--|
| 0010        | CON 010 M ST HDR PC NLK DRW 100 9.86MM  | 1.000 | TE CONNECTIVITY  | 5103308-                      | Pl   |
| 0020        | TEST POINT 0.05ID LOOP WHT BASE         | 10    | KEYSTONE         | 5002                          | EN, GPIO1, GPIO2, GPIO3, GPIO4, ISNSM_BUCK, ISNSP_ |
| 0030        | TEST POINT 0.05ID LOOP RED BASE         | 7.000 | KEYSTONE         | 5000                          | IN_M, IN_P, LD02P5V_IN, LD02P5V_OUT, LD05V, REG_I  |
| 0040        | TEST POINT 0.05ID LOOP BLK BASE         | 6.000 | KEYSTONE         | 5001                          | GND, GND1, GND2, GND3, GND4, GND5                  |
| 0050        | IND 10U0 8A00 500 37.0X37.0X1.80MM      | 1.000 | WURTH ELECTRONIK | 760308201                     | RX1  |
| 0051        | IND 10U4 OR20 WIRELESS RX COIL 48X32MM  | 1.000 | TDK              | WR-483250-15M2-               | ALTERNATE FOR RX1                                  |
| 0060        | CON 001 F ST OTH PC NLK SRW 000 TST PNT | 2.000 | HARWIN           | s<br>s1751-                   | J5,J6  |
| 0070        | RES OROO MF OW10 Z 0603 THNF JUMPER     | 1.000 | VISHAY           | 46<br>MCT06030Z0000ZP500      | R86  |
|             |   | 7.000 | KOA SPEER        | RK73B1ETTP103J                | R64,R66,R67,R88,R44,R87,R89                        |
|             |   |       | PANASONIC        | ERJ-                          |  |
| 0080        | RES 10K0 MF W063 J 0402 THKF 200PPM/C   |       | VISHAY           | CRCW040210K0JNED              |  |
|             |   |       | YAGEO            | RC0402JR-                     |  |
| 0090        | RES 2K20 MF 0W10 J 0402 THKF 200PPM/C   | 2.000 | PANASONIC        | ERJ-                          | R78,R79  |
|             |   | 1.000 | IRC              | ZGEJZZZX<br>WCR-WCR0603LF-    | R47  |
|             |   |       | KOA SPEER        | 4R70JELT<br>RK73B1JTTD4R7J    |  |
| 0100        | RES 4R70 0W10 J 0603 THKF 400PPM/C      |       | VISHAY           | CRCW 0603-4R70J-KEA-          |  |
|             |   |       | YAGEO            | E3<br>RC0603JR-               |  |
| 0110        | RES R033 0W33 J 0805 THKE -0/+250PPM/C  | 1.000 | ROHM             | 074R7L<br>UCR10EVHJSR033      | Rl   |
|             |   | 2.000 | KOA SPEER        | RK73H1HTTC1001F               | R2,R3  |
|             |   |       | VISHAY           | CRCW02011K00FNED              |  |
| 0120        | RES 1K00 W050 F 0201 THKF 200PPM/C      |       | YAGEO            | RC0201FR-                     |  |
|             |   |       | PANASONIC        | ERJ-                          |  |
|             |   | 1.000 | KOA SPEER        | RK73Z1HTTC                    | R95  |
|             |   |       | TT ELECTRONICS   | WCR-WCR0201LF-                |  |
| 0130        | RES 0R00 W050 F 0201 THKF               |       | VISHAY           | CRCW02010000Z0ED              |  |
|             |   |       | YAGEO            | RC0201JR-                     |  |
|             |   |       | PANASONIC        | ERJ-                          |  |
|             |   | 2.000 | KOA SPEER        | 1GN0R00C<br>RK73B1HTTC104J    | R43,R84  |
|             |   |       | PANASONIC        | ERJ-                          |  |
| 0140        | RES 100K MF 0W05 J 0201 THKF 200PPM/C   |       | VISHAY           | 1GEJ104C<br>CRCW0201100KJNED  |  |
|             |   |       | YAGEO            | RC0201JR-                     |  |
|             |   | 1.000 | PANASONIC        | 07100KL<br>ERJ-               | R85  |
| 0150        | RES 15K0 MF 0W05 F 0201 THKF 200PPM     |       | VISHAY           | 1GEF1502C<br>CRCW020115K0FNED |  |
|             |   | 1.000 | TAIYO YUDEN      | TMK105BJ105MV-                | C13  |
| 0170        | CAP 10000 MLC X5R 25V0 M 0402 0.55MM    |       | TDK              | F<br>C1005X5R1E105M050BC      |  |
|             |   | 1.000 | AVX              | 04025C222KAT2A                | C29  |
|             |   |       | KEMET            | C0402C222K5RACTU              |  |
| 0180        | CAP 2200P MLC X7R 50V0 K 0402 0.56MM    |       | MURATA ERIE      | GRM155R71H222KA01D            |  |
|             |   |       | TDK              | C1005X7R1H222K050BA           |  |
|             |   |       | YAGEO            | CC0402KRX7R9BB222             |  |
|             |   | 2.000 | TDK              | CGA2B3X7R1H223K050BB          | C14,C20  |
|             |   |       | KEMET            | C0402C223K5RACTU              |  |
| 0190        | CAP 0U022 MLC X7R 50V0 K 0402 0.55MM    |       | MURATA ERIE      | GRM155R71H223KA12D            |  |
|             |   |       |                  |                               |  |

Note 1 - Recommended capacitor temperature/dielectric and voltage ratings. 50V capacitors are recommended for C14, C15, C16, C17, C20, C21 C28, C29, C31, C32. Furthermore, C0G/NPO-type capacitor values stay constant with voltage while X7R and X5R capacitor values derate over the working voltage range at 40% to over 80%. The decision to use lower voltage lower voltage rated capacitors or other type temperature/dielectric capacitors is left to the end user.

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#### Table 1. Bill of materials Continued(IDTP9023 Dual-Mode Demo PCB V1.2)

|             |   |       |                            | ,  |                        |
|-------------|---|-------|----------------------------|--|------------------------|
| Item Number | Description   | Qty   | Manufacturer               | Mfr Part Number                          | Ref Designator         |
|             |   | 2.000 | TDK                        | CGA2B3X7R1H223K050BB                     | c14,c20                |
| 0190        | CAP 00022 MLC X7R 50V0 K 0402 0.55MM                                  |       | KEMET                      | C0402C223K5RACTU                         |                        |
|             |   |       | MURATA ERIE                | GRM155R71H223KA12D                       |                        |
|             |   |       | TAIYO YUDEN                | UMK105B7222KV-<br>F                      |                        |
| 0200        | CAP 0U047 MLC X7R 50V0 K 0402 0.55MM                                  | 2.000 | TDK                        | C1005X7R1H473K050BB                      | C15,C16                |
| 0210        | CAP 10U00 MLC X5R 10V0 M 0402 0.70MM                                  | 3.000 | SAMSUNG                    | CL05A106MP5NUNC                          | C1,C26,C3              |
|             |   | 1.000 | KEMET                      | C0603C683K5RAC                           | C32                    |
| 0220        | CAP 0U068 MLC X7R 50V0 K 0603   |       | TDK                        | C1608X7R1H683K                           |                        |
|             |   | 2.000 | KEMET                      | C0603C104K5RAC                           | C28,C31                |
|             |   |       | TDK                        | C1608X7R1H104K                           |                        |
| 0230        | CAP 0U100 MLC X7R 50V0 K 0603   |       | MURATA ERIE                | GRM188R71H104KA93D                       |                        |
|             |   |       | TDK                        | C1608X7R1H104K080AA                      |                        |
| 0240        | CAP 10U00 MLC X5R 25V0 M 0603 0.9MM                                   | 6.000 | SAMSUNG                    | CL10A106MA8NRNC                          | C10,C43,C44,C45,C48,C7 |
|             |   |       | TDK                        | C1608X5R1E106M080AC                      |                        |
| 0250        | CAP 0U330 MLC X5R 50V0 K 0603 0.9MM                                   | 2.000 | TDK                        | C1608X5R1H334K080AB                      | C17,C21                |
| 0260        | CAP 0U100 MLC X5R 25V0 K 0201 0.3MM                                   | 4.000 | SAMSUNG                    | CL03A104KA3NNNC                          | C39,C41,C42,C47        |
|             |   |       | TDK                        | C0603X5R1E104K030BB                      |                        |
| 0270        | CAP 0U047 MLC X5R 25V0 K 0201 0.3MM                                   | 1.000 | TDK                        | C0603X5R1E473K030BB                      | Ċ9                     |
| 0280        | CAP 1U000 MLC X5R 6V30 M 0201 0.35MM                                  | 1.000 | AVX                        | 02016D105MAT2A                           | C2                     |
|             |   |       | MURATA ERIE                | GRM033R60J105MEA2D                       |                        |
|             |   |       | TDK                        | C0603X5R0J105M030BC                      |                        |
| 0290        | CAP 1U000 MLC X5R 10V0 M 0201 0.35MM                                  | 3.000 | SAMSUNG                    | CL03A105MP3NSNC                          | C4,C46,C6              |
| 0300        | CAP 0U220 MLC X5R 25V0 K 0201 0.35MM                                  | 2.000 | TDK                        | C0603X5R1E224K030BC                      | C5,C8                  |
| 0310        | CAP 0U047 MLC X5R 16V0 K 0201 0.33MM                                  | 1.000 | MURATA ERIE                | GRM033R61C473KE84D                       | C12                    |
|             |   |       | TAIYO YUDEN                | EMK063BJ473KP-<br>F                      |                        |
| 0320        | IND 1U00 2A50 R078 2.7X2.2X1.0MM                                      | 1.000 | токо                       | 1269AS-H-<br>1ROM                        | L1                     |
| 0330        | DIO SKY 60V0 1A00 POWERDI123 DFLS160-7                                | 1.000 | DIODES INCORPORATED        | DFLS160-<br>7                            | D9                     |
| 0331        | DIO SKY 40V0 0A50 SOD123 B0540W-7-F                                   | 1.000 | DIODES INCORPORATED        | B0540W-7-<br>F                           | ALTERNATE FOR D9       |
| 0340        | DIO SKY 40V0 1A00 2DSN NSR10F40NXT5G                                  | 5.000 | ON SEMICONDUCTOR           | NSR10F40NXT5G                            | D10,D11,D12,D13,D3     |
| 0350        | FET DNN 60V0 8A20 R017 POWER33 FDMC89521                              | 1.000 | FAIRCHILD                  | FDMC89521L                               | Q2                     |
| 0360        | IC MEM TDFN08 64KBYTE EEPROM 400KHZ I2C                               | 1.000 | MICROCHIP TECHNOLOGY       | 24AA64T-<br>I/MNY                        | 03                     |
| 0370        | IC BGA-79 IDTP9023 DUAL MODE RX                                       | 1.000 | IDT                        | P9023WLCSP                               | U1                     |
| 0380        | PCB IDTP9023 CSP DEMO   | 1.000 | COASTAL CIRCUITS           | 61-<br>23060143                          |                        |
|             |   |       | VECTOR                     | 61-<br>23060143                          |                        |
| 0390        | BOX BLACK WIRELESS  | 1.000 | POLYCASE                   | J-<br>7674ABR1                           |                        |
|             |   |       | UTHMANN MOLD & MACHINE INC | 61-21500074 (MODIFIED FROM J-<br>7674AB) |                        |
| 0400        | SCW 004 0038 PAN PHL STL ZNC  | 4.000 | B&F FASTENERS              | PSMS 004 0038 PH                         |                        |
|             |   |       | OLANDER                    | 4N37PPAZR                                |                        |
| 0410        | KAPTON TAPE 2 MIL 1.5IN X 36YD  | .020  | DUPONT                     | KPT2-<br>1 1/2                           |                        |
| 8000        | DRW PCB IDTP9023 CSP DEMO   | 1.000 |                            |  |                        |
| 8010        | DRW SCH IDTP9023 CSP DEMO   | 1.000 |                            |  |                        |
| 8020        | ASSUME ANY REFERENCE DESIGNATOR NOT LISTED ON<br>BOM IS NOT POPULATED | 1.000 |                            |  |                        |

Note 1 - Recommended capacitor temperature/dielectric and voltage ratings. 50V capacitors are recommended for C14, C15, C16, C17, C20, C21 C28, C29, C31, C32. Furthermore, C0G/NPO-type capacitor values stay constant with voltage while X7R and X5R capacitor values derate over the working voltage range at 40% to over 80%. The decision to use lower voltage lower voltage rated capacitors or other type temperature/dielectric capacitors is left to the end user.

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Figure 2. Assembly Placement Map





Figure 3. Top and Top Silkscreen Layer





Figure 4. Bottom and Bottom Silkscreen Layer.





Figure 5. Mid 1 Layer



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Figure 6. Mid 2 Layer



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#### **OPTIONAL WINDOWS GUI**

The I<sup>2</sup>C USB adapter (JM60) is optional and the main purpose is to upload the IDTP9023 firmware into the EEPROM (U3). The I<sup>2</sup>C adapter may be used to interface the IDTP9023 and the PC GUI – see detailed description on "*Installing the Windows GUI*" section:

- Install the Wireless Power Demo Windows GUI software by executing the Setup.exe file from the CDROM in the folder "9020Tool\_final" (Figure 7).
- Connect the USB cable from a PC to the 1" x 2" JM60 programming board. The JM60 board has already been programmed.
- 5. Connect the JM60 to the connector on the IDTP9023 CSP DEMO PCB board (J1 Fig 8).
- Click Start >> All Programs >> Integrated Device Technology (Folder) >> Wireless Power Demo (Application Icon) to open the GUI software (Fig 9).



Figure 7. File folder structure on the CDROM.



Figure 8. IDTP9023-EVAL JM60 Programmer input 10pin header.



Figure 9. Starting the Graphical User Interface

#### Verifying Connectivity

You can verify that the IDTP9023 is properly connected to your computer and able to communicate to the evaluation board by looking at the lower left of Figure 10. It should state "USB Connected". Otherwise it will state in Red letters: "USB Disconnected – Check Connection".

If it states USB Disconnected, it might be that the driver was not properly installed on the PC. Check to see that a USB Connector icon appears and disappears, at the lower right of the Taskbar, as the Cable's USB Connector is plugged and unplugged from the USB port. If it does not appear, then proceed to Troubleshooting section.

| MAIN EEPROM                                  |        |       |    |   |   |
|--|--------|-------|----|---|---|
| <ul> <li>WPC Ping</li> <li>Config</li> </ul> |        | 750 - | 1  |   |   |
| Power Transfer                               |        | 600-  |    |   |   |
| FOD 1  | t / mÅ | 450-  |    |   |   |
| FOD 2  | Curren | 200   |    |   |   |
| FOD 4  | 3      | 300-  |    |   |   |
|  |        | 150-  | Λ  | Λ | ٨ |
| 175.1 kHz                                    |        | 0-    |    |   |   |
| Log Messages                                 |        | 54    | 13 |   |   |

Figure 10. Windows GUI Main tab

### **OPTIONAL - Installing the Windows GUI**

For the first time use of the IDTP9023-DEMO board or to write a new .bin file into the EEPROM, the Windows Drivers and GUI must be installed to communicate with the JM60 USB to I<sup>2</sup>C controller that is located on the JM60 Programmer Dongle board. The JM60 Dongle board is attached to the left side of the DEMO board, and is connected via a 10pin keyed header on the bottom side of the board. The purpose of this controller is to be able to write different .bin files into the EEPROM on the DEMO board, and to be able to acquire real time signals showing system operation. Different .bin files can be made available, for example, when a different output power setting test is desired.

Example installation of the Windows USB-to I<sup>2</sup>C-Drivers on a Win7 32-bit or 64-bit system is shown in the following steps:

To install the GUI, open the IDTP9023-DEMO CD and run the file: setup-1.0.0.11.exe within the 9020Tool\_final folder. I.e. the path is 9020Tool\_final/setup-1.0.0.11.exe shown in figure 11. Follow the Setup Wizard instruction shown in Figure 12. This will install the GUI and driver automatically. After the installation process is complete, you may connect the evaluation board to the computer with the USB cable, via the Dongle, and use the software tool. At this point, a little USB icon should appear at the lower right of the desktop screen. If it does not, then the machine being used should be rebooted. Now plug the USB cable into the OSB cable into the OSB cable into the PC. Then connect the JM60 dongle board into the evaluation board.



### Writing to the EEPROM

#### Loading the XXXX.bin File

As mentioned, the EEPROM already comes with a standard BIN file programmed into it, which gets downloaded to the IDTP9023 upon power up. However, if another one has been provided by the factory, for instance, for perhaps a higher output power, the way to write it into the EEPROM is as follows:

- 1) Plug the USB cable from the computer to the dongles USB type B connector.
- 2) Plug the dongle into the IDTP9023 Demo board. Connect a 7.5V power supply to the REG\_IN and GND test points on the IDTP9023 Demo Board (Fig 13 left). Alternately, place the demo board on a powered Tx transmitter.
- 3) Click Start >> All Programs >> Integrated Device Technology (Folder) >> Wireless Power Demo.
- 4) Choose "RECEIVER".
- 5) Click on the EEPROM tab directly right of the MAIN tab.
- 6) Click on the Load Bin file and browse to the path where the new bin file is located, for example, on the CD (type .bin).
- 7) Set the EEPROM Slave ID to 50 and select the Scan I<sup>2</sup>C button (Fig 13 lower right) and check that the slave address for the EEPROM appears as 0x50.
- 8) Click the Write EEPROM button, the green progress bar should increase in size from left to right and two green passes should be observed as the file is written to the EEPROM and then the Write OK should appear at the bottom of the screen. If not, click the Write EEPROM button again until Write OK appears.
- 9) Finally, to get the LEDs on the DEMO board to start flashing, the Reset Target check mark has to be unchecked. Uncheck it and the various LEDs will start flashing.

If a Write OK is not shown in step 8, then refer to the Troubleshooting section on page 13. "Error Writing" is shown in place of "Write OK", and it should be easily visible that FF's will be shown across the entire 0x0000 address row or simply that the EEPROM Content View doesn't match the .ROM File Content View. Note: The left Content view shows the current EEPROM contents and can be seen by clicking on the Load EEPROM Content. The Right side Content view is the Bin file that was loaded.

|  | DIDT - Wireless Power Solution   |   |  |  |
|--|--|---|--|--|
| REG_IN and GND Test<br>Points  | Integrated Device Technology   | OT Wireless Power Solution User Interface   |  |  |
| State of the second sec | MAIN EEPROM Debug Config. and Status   |   |  |  |
|  | EEPROM Content View  | .ROM File Content View  |  |  |
| Green<br>Progress<br>Bar   | 0x0000         07 84 75 06 82 IF FF BD 05 39 00 00 10 00 CC A8           0x0010         00 DD 15 CC 01 EF DD 01 CC 15 90 DD 05 CC 0F 6E           0x0020         DD 03 CC 0A 99 DD 07 CE FF FZ CC 03 C1 ED 00 CE           0x0030         FF F0 CC 03 15 ED 00 CE FF FZ CC 03 C1 ED 00 CE           0x0050         DF 05 CC 05 35 ED 00 CE FF FZ CC 03 C1 ED 00 CE           0x0050         FF E0 CC 03 15 ED 00 CE FF FZ CC 03 C1 ED 00 CE           0x0050         FF E1 CC 04 13 ED 00 B0 01 EF 39 C6 20 37 34 18           0x0050         FF 18 3C CC 00 90 BD 18 11 83 81 83 BD           0x0050         CE 1F 78 18 CC C0 00 99 BD 18 11 83 81 83 BD           0x0050         CE 10 00 CE 17 28 BD 19 F6 31 31 BD 15 78 18           0x0050         CE 00 00 E1 80 F1 27 F0 00 03 90 FC E 98 0A C6 01           0x0050         CE 00 00 E7 00 14 LA 93 12 27 26 DE 12 18 CE           0x0050         DE 00 00 F7 00 DE 78 38 F90 38 DF FE 38 BF           0x0050         CE 00 00 E7 00 DE 00 EF 38 BF9 00 38 DF 6E 38 BF           0x0050         CE 00 DE 00 EF 70 05 E0 00 DD 28 ED 28 38 DF           0x0050         EE 00 EF 00 BE 00 E7 30 BF 03 81 DF 13 31 39 34           0x0050         EE 00 EF 08 ED 02 72 70 D1 C0 02 07 FB 00 C1 14 C6           0x0050         EE 80 DD 03 8B D 44 DD B0 15 87 F0 01 14 C6           0x0050         EF 8B D0 03 88 D 68 D 19 13 31 31 EE 18 CF 4D           < | 0x0000         07         84         7F         66         82         1F         FF         8D         83         00         00         10         0CC         A8         A           0x0010         00         DD         15         CC         01         EF         DD         15         CC         01         CC         15         90         DD         05         CC         07         EF         FZ         CC         03         CC         03         15         DC         01         CC         15         90         DD         05         CC         07         62         17         25         90         DC         CC         03         CC         03         15         DD         05         CC         03         CC         03         CC         03         EE         DC         04         01         DO         CE         CC         04         15         DO         CE         00         CE         14         18         18         18         88         DD         00         CE         00         CE         15         74         18         18         DD         18         DE         18         18 |  |  |
| avos DDD   | Load EEPROM Content Write EEPROM   | Load BIN File   |  |  |
| 1  | EEPROM SlaveID 0x 50   | Save EEPROM to File   |  |  |
| RESET Test Point   | I2C Speed 400 ▼ kB/s   | Scan I2C  |  |  |
|  | USB Connected Write OK   |   |  |  |

Reset Target field needs to be unchecked after Write OK! It also serves as a very convenient system reset tool if the I<sup>2</sup>C bus disconnects. Check the box and then uncheck it to reset the system.

Figure 13. Connection for external supply connected to REC\_OUT and location of the RESET Switch. The GUI screen after Loading a BIN File and Writing to the EEPROM.



### Troubleshooting

The IDTP9023 demo board was designed to quickly show the performance of the IDTP9023. However, if you are experiencing trouble getting started, here are some tips to help accelerate setup and connectivity.

- Check to make sure that the PC shows it is connected to the demo board. USB connected should always show at the lower left of the Dongle GUI. If it doesn't it is always good practice to disconnect and reconnect the USB cable. Unplugging and plugging the USB cable should show an icon appearing and disappearing at the lower right of your computer screen.
- Reset the JM60 by momentarily connecting a jumper wire from pin 4 on the J2 connector to ground. The USB will disconnect and reconnect on the GUI Screen (See Figure 10 left). When the wire is removed, program the EEPROM.
- Select the Scan I<sup>2</sup>C button (Fig 13 lower right) and check that the slave address for the EEPROM appears as 0x50
- 4. Reload the .bin file and re-write it. Make sure WRITE OK shows at the middle of the display after a write takes place.
- 5. <u>Update the Driver</u>. If you have a previous version of the eval tool, the driver will probably need to be updated. The way to check on the version of the driver is to open up the Device Manager as shown in Figure 14. Expand the USB Bridge Devices and double click on it. Click on the Driver Tab, and be sure its' Driver Date is 7/5/2009 and Version is 7.0.0.0. See Figure 16. If it is not version 7.0.0.0 then go to directory C:\Program Files\IDT Wireless Power Solution\Drv as shown in Figure 17 and double click the DPInst.exe file. The system will then go through a driver update install. Be sure to reboot your machine once the install is complete.



Figure 14. Resetting the JM60.

Checking the revision of the driver using Device Manager, shown is a Win7 PC.



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Figure 15. Checking the revision of the driver in Device Manager.

| 101010.                   |   |
|---------------------------|---|
| IDT USB Bridge Properties | ×   |
| General Driver Details    |   |
| IDT USB Bridge            |   |
| Driver Provider:          | IDT   |
| Driver Date:              | 7/5/2009  |
| Driver Version:           | 7.0.0.0   |
| Digital Signer:           | Not digitally signed  |
| Driver Details            | To view details about the driver files.   |
| Update Driver             | To update the driver software for this device.  |
| Roll Back Driver          | If the device fails after updating the driver, roll<br>back to the previously installed driver. |
| <u>D</u> isable           | Disables the selected device.   |
| <u>U</u> ninstall         | To uninstall the driver (Advanced).   |
|                           | OK Cancel   |

Figure 16. Checking that the revision of the driver is correct.

| 🕞 🗢 📕 🕨 Compu         | ter 🕨 Local Disk (C:) | Progra                                | m Files ► 1 | IDT Wireless Powe | r Solution 🕨 Dr | / •               | ✓ Search D        | rv   |        |   |
|-----------------------|-----------------------|---------------------------------------|-------------|-------------------|-----------------|-------------------|-------------------|------|--------|---|
| rganize 🔻 🛛 Include   | in library 🔹 Share    | with 🔻                                | Burn        | New folder        |                 |                   |                   | • == |        | ( |
| MSBuild               |                       | * N                                   | ame         | ~                 |                 | Date modified     | Туре              | Size |        |   |
| MSXIML 4.0            |                       |                                       | amd64       |                   |                 | 3/16/2012 4:25 PM | File folder       |      |        |   |
|                       | ation                 |                                       | ia64        |                   |                 | 3/16/2012 4:25 PM | File folder       |      |        |   |
|                       |                       | n 🌒                                   | x86         |                   |                 | 3/16/2012 4:25 PM | File folder       |      |        |   |
| P 📕 Reference Asse    | mblies                | -                                     | DPInst.ex   | e                 |                 | 11/2/2006 5:22 AM | Application       |      | 532 KB |   |
| P Koxio               |                       | i i i i i i i i i i i i i i i i i i i | idt_usb_b   | ridge.inf         |                 | 1/27/2012 8:04 PM | Setup Information |      | 3 KB   |   |
| Symantec<br>Symantics |                       | 6                                     | MyCatFile   | e.cat             |                 | 10/5/2010 1:06 PM | CAT File          |      | 1 KB   |   |

Figure 17. Installed Device Driver Directory.

## **ORDERING GUIDE**

Table 2. Ordering Summary

| PART NUMBER MARKING |                            | PRICE    | AMBIENT TEMP.<br>RANGE | SHIPPING CARRIER | QUANTITY |
|---------------------|----------------------------|----------|------------------------|------------------|----------|
| IDTP9023-EVAL       | IDTP9023 CSP DEMO PCB V1.2 | \$149.00 | 0°C to +70°C           | Box 14"x10"x2"   | 1        |

### **Revision History**

September 27, 2013 Version 1.0 – Initial Release.

October 10, 2013 Version 1.1 – Update to the new board revision V1.1.

October 15, 2013 Version 1.2 – Update to a new diode NSR10F40NXT5G.

December 10, 2013 Version 1.3 – Update to a new board reversion PCB V1.2.

January 9, 2014 Version 1.4 – Update assembly drawing to include designators.



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